

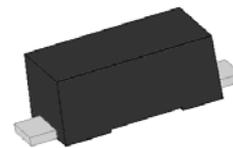


### DESCRIPTION

The sidac is a silicon bilateral voltage triggered switch with greater power-handling capabilities than standard diacs. Upon application of a voltage exceeding the sidac breakover voltage point, the sidac switches on through a negative resistance region to a low on-state voltage. Conduction continues until the current is interrupted or drops below the minimum holding current of the device.

### APPLICATIONS

- ✧ High-voltage lamp ignitors
- ✧ Natural gas ignitors
- ✧ Gas oil ignitors
- ✧ High-voltage power supplies
- ✧ Xenon ignitors
- ✧ Overvoltage protector
- ✧ Pulse generators
- ✧ Fluorescent lighting ignitors HID lighting ignitors



SOD-123FL



Symbol

### FEATURES

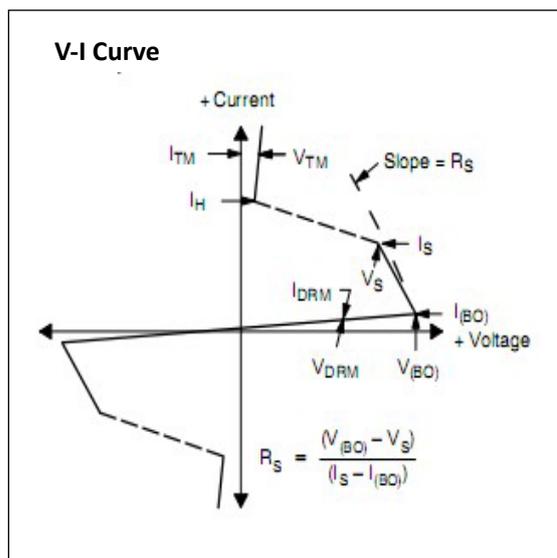
- ✧ Excellent capability of absorbing transient surge
- ✧ Quick response to surge voltage (ns Level)
- ✧ Glass-passivated junctions
- ✧ High voltage lcmp ignitors

### ABSOLUTE MAXIMUM RATINGS (TA=25°C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	T <sub>STG</sub>	-40 to +125	°C
Operating junction temperature range	T <sub>J</sub>	-40 to +125	°C
On-state RMS current	I <sub>T</sub>	1.0	A
Maximum surge on-state current non-repetitive one cycle peak value (50Hz)	I <sub>TSM</sub>	16.7	A
Critical rate-of-rise of on-state current	di <sub>T</sub> /dt	80	A/μs

ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C)

Symbol	Parameter
V <sub>DRM</sub>	Peak off-state voltage
I <sub>DRM</sub>	Off-state current
V <sub>S</sub>	Switching voltage
I <sub>S</sub>	Switching current
R <sub>S</sub>	Switching resistance
V <sub>T</sub>	On-state voltage
I <sub>H</sub>	Holding current
V <sub>BO</sub>	Breakover voltage
I <sub>BO</sub>	Breakover current



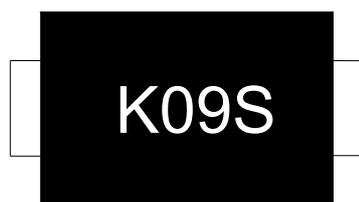
ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C, continued)

Part Number	I <sub>DRM</sub> @V <sub>DRM</sub>		V <sub>BO</sub>		I <sub>BO</sub>	V <sub>T</sub> @I <sub>T</sub> =1A	I <sub>H</sub>	R <sub>S</sub>	Marking
	μA	V	V		μA	V	mA	kΩ	
	max	min	min	max	max	max	min	min	
K0900SD1	1	70	80	97	50	2	10	0.1	K09S
K1050SD1	1	90	95	113	50	2	10	0.1	K10S
K1200SD1	1	100	110	125	50	2	10	0.1	K12S
K1300SD1	1	110	120	138	50	2	10	0.1	K13S
K1400SD1	1	120	130	146	50	2	10	0.1	K14S
K1500SD1	1	130	140	170	50	2	10	0.1	K15S
K1800SD1	1	160	170	195	50	2	10	0.1	K18S
K2000SD1	1	180	190	215	50	2	10	0.1	K20S
K2200SD1	1	190	205	230	50	2	10	0.1	K22S
K2400SD1	1	200	220	250	50	2	10	0.1	K24S
K2600SD1	1	220	240	270	50	2	10	0.1	K26S

## ORDERING INFORMATION

K	220	0	SD1
Series code K:Sidac	Median voltage	0: Bi-direction 1: Uni-direction	Package type:SOD-123FL

## MARKING

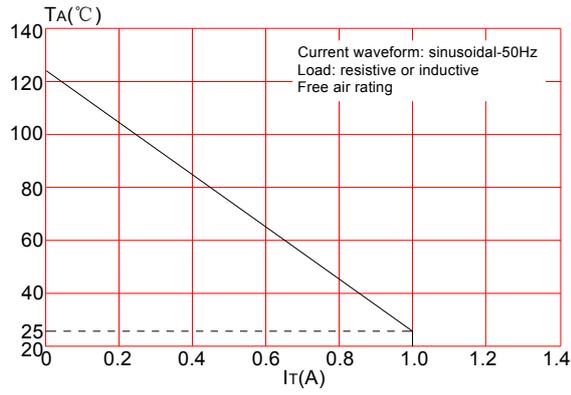


K09S: Device Marking Code

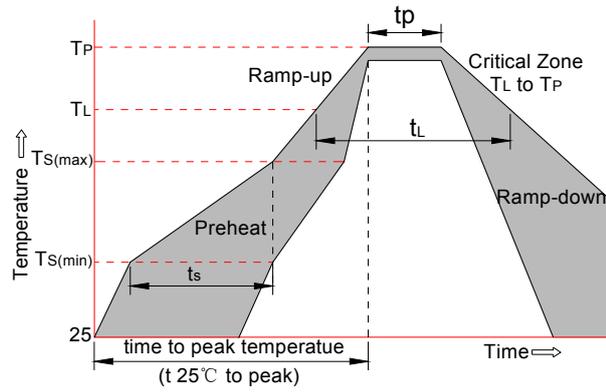
## SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see FIG.2)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquidus)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_P$ )		8 min. Max
Do not exceed		+260°C

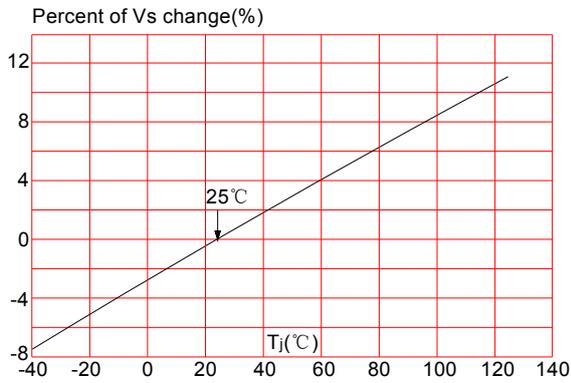
**FIG.1:** Maximum allowable ambient temperature versus on-state current



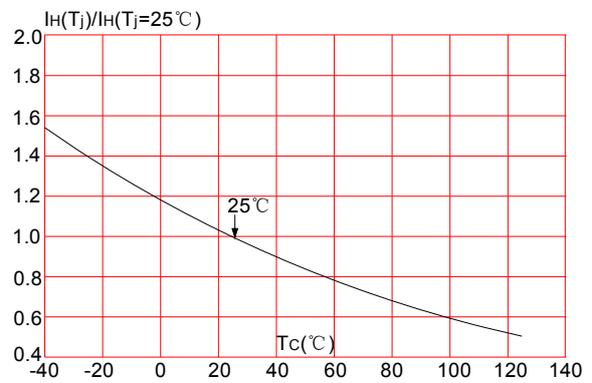
**FIG.2:** Reflow condition



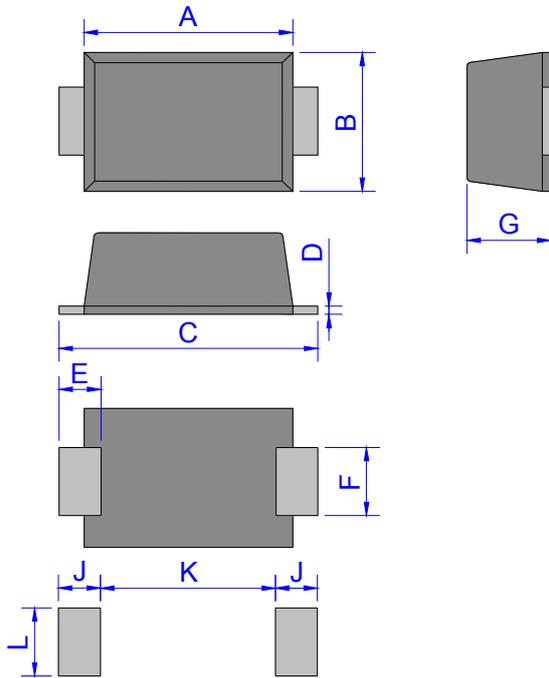
**FIG.3:** Normalized  $V_s$  change vs. junction temperature



**FIG.4:** Normalized DC holding current vs. case temperature



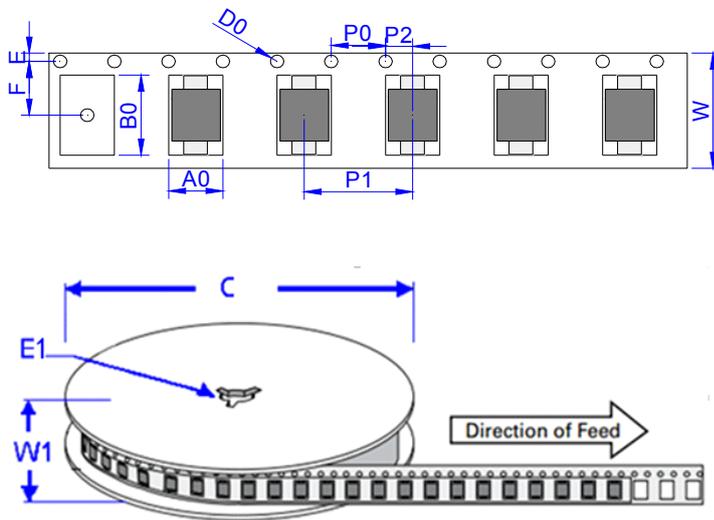
PACKAGE MECHANICAL DATA



SOD-123FL

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.60	3.00	0.102	0.118
B	1.60	2.00	0.063	0.079
C	3.45	3.95	0.136	0.156
D	0.10	0.25	0.004	0.01
E	0.3	0.9	0.012	0.035
F	0.80	1.20	0.031	0.047
G	0.70	1.00	0.028	0.039
J	1.30		0.051	
K		1.70		0.067
L	1.30		0.051	

TAPE AND REEL SPECIFICATION-SOD-123FL



Ref.	Dimensions	
	Millimeters	Inches
A0	1.95 ± 0.3	0.077 ± 0.012
B0	3.95 ± 0.3	0.156 ± 0.012
C	178	7.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	3.50 ± 0.2	0.138 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	4.00 ± 0.2	0.157 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	8.0 ± 0.2	0.315 ± 0.008
W1	11.5 ± 1.0	0.453 ± 0.039

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
KxxxxSD1	0.0144	3000	150,000	7 inch reel pack

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